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## FQA11N90C-F109

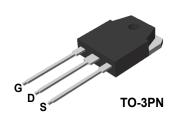
# N-Channel QFET $^{\rm @}$ MOSFET 900 V, 11.0 A, 1.1 $\Omega$

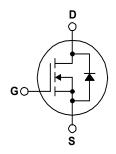
#### **Features**

- 11 A, 900 V,  $R_{DS(on)}$  = 1.1  $\Omega$  (Max.) @  $V_{GS}$  = 10 V,  $I_{D}$  = 5.5 A
- Low Gate Charge (Typ. 60 nC)
- Low Crss (Typ. 23 pF)
- 100% Avalanche Tested
- · RoHS compliant

#### **Description**

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and elec-tronic lamp ballasts.





#### **MOSFET Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter			FQA11N90C_F109	Unit
$V_{DSS}$	Drain to Source Voltage			900	V
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25°C)		11.0	Α
	Drain Current	- Continuous (T <sub>C</sub> = 100°C)		6.9	Α
DM	Drain Current	- Pulsed	(Note 1)	44.0	Α
$V_{GSS}$	Gate to Source Voltage			± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy			960	mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	11.0	Α
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	30	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.0	V/ns
$P_{D}$	Power Dissipation	(T <sub>C</sub> = 25°C)		300	W
		- Derate Above 25°C		2.38	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C

#### **Thermal Characteristics**

Symbol	Parameter	FQA11N90C_F109	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max	0.42	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max	40	°C/W

## **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQA11N90C-F109	FQA11N90C	TO-3PN	Tube	N/A	N/A	30 units

## **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	900			V
$\Delta BV_{DSS}$ / $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25°C		1.02		V/°C
	7 0 1 1/4 5 1 0 1	V <sub>DS</sub> = 900 V, V <sub>GS</sub> = 0 V			10	μΑ
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 720 V, T <sub>C</sub> = 125°C	-		100	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V	-		-100	nA
On Cha	racteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0		5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5.5 A		0.91	1.1	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 5.5 A	1	9.0		S
	ic Characteristics	I		L 0500		
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$		2530	3290	pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		215	280	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			23	30	pF
Switchi	ng Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 450 V, I <sub>D</sub> = 11.0 A,	-	60	130	ns
t <sub>r</sub>	Turn-On Rise Time	$R_G = 25 \Omega$	I	130	270	ns
$t_{d(off)}$	Turn-Off Delay Time		I	130	270	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)		85	180	ns
$Q_g$	Total Gate Charge	V <sub>DS</sub> = 720 V, I <sub>D</sub> = 11.0 A,	-	60	80	nC
$Q_{gs}$	Gate-Source Charge	V <sub>GS</sub> = 10 V		13		nC
$Q_{gd}$	Gate-Drain Charge	(Note 4)	-	25		nC
Drain-S	ource Diode Characteristics ar	nd Maximum Ratings				
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				11.0	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				44.0	Α
$V_{SD}$	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 11.0 A			1.4	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 11.0 A,		1000		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> / dt = 100 A/μs		17.0		μС

#### Notes:

 $<sup>{\</sup>it 1. Repetitive\ rating: pulse\ width\ limited\ by\ maximum\ junction\ temperature.}$ 

<sup>2.</sup> L = 15 mH, I<sub>AS</sub> = 11.0 A, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , starting T<sub>J</sub> = 25°C.

<sup>3.</sup> I  $_{SD} \leq$  11.0 A, di/dt  $\leq$  200 A/µs, V  $_{DD} \leq$  BV  $_{DSS,}$  starting  $~T_{J}$  = 25°C.

<sup>4.</sup> Essentially independent of operating temperature.

## **Typical Characteristics**

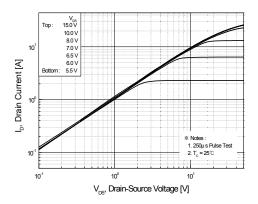


Figure 1. On-Region Characteristics

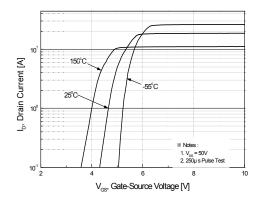


Figure 2. Transfer Characteristics

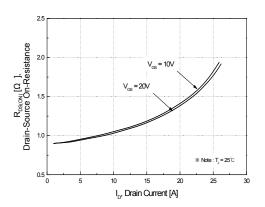


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

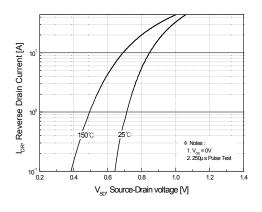


Figure 4. Body Diode Forward Voltage Variation with Source Current

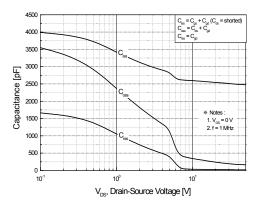


Figure 5. Capacitance Characteristics

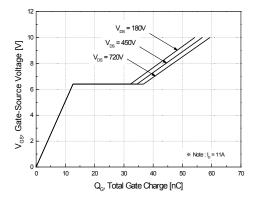


Figure 6. Gate Charge Characteristics

### Typical Characteristics (Continued)

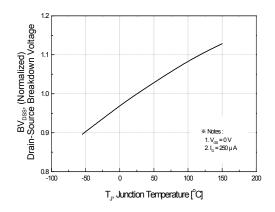
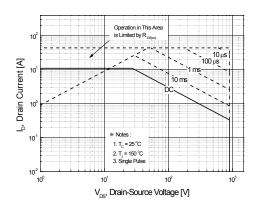


Figure 7. Breakdown Voltage Variation

Figure 8. On-Resistance Variation



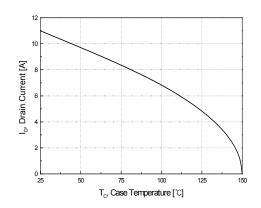


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs Case Temperature

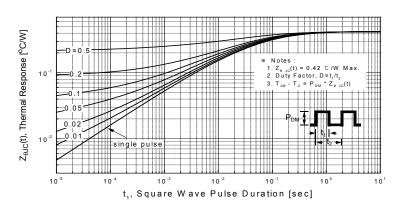


Figure 11. Transient Thermal Response Curve

Figure 12. Gate Charge Test Circuit & Waveform

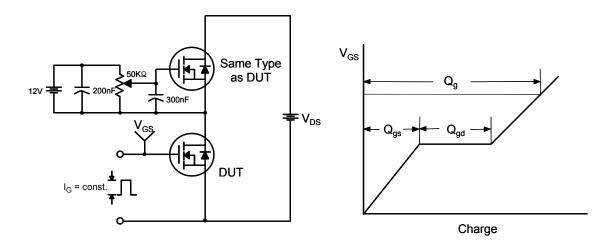


Figure 13. Resistive Switching Test Circuit & Waveforms

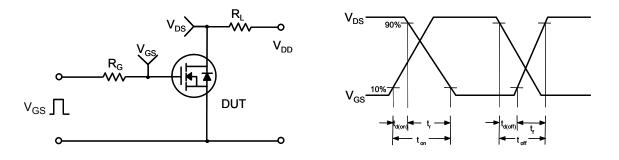
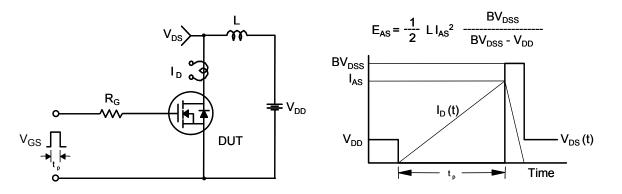


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



DUT

VDS

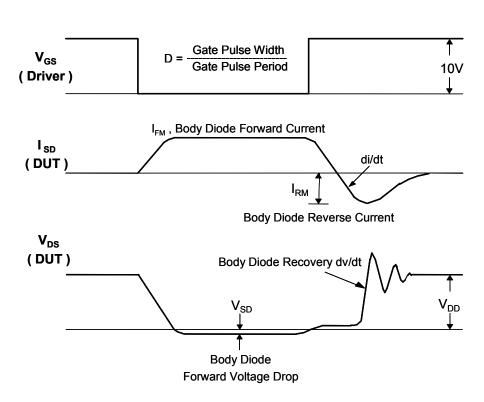
Driver

Same Type
as DUT

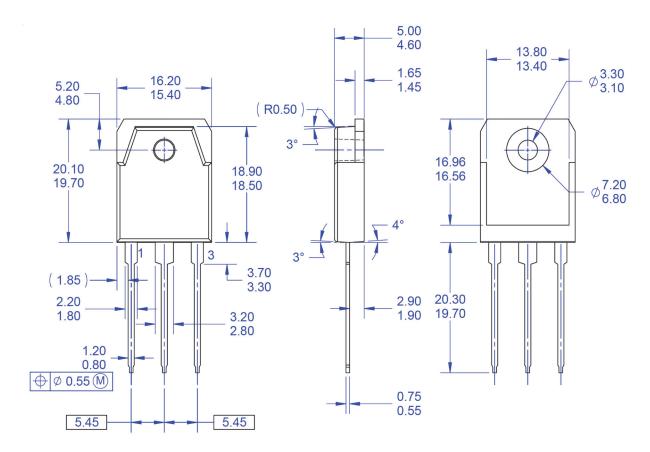
• dv/dt controlled by R<sub>G</sub>
• I<sub>SD</sub> controlled by pulse period

 $\prod V_{GS}$ 

Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



## **Mechanical Dimensions**



(R0.50)

#### NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO EIAJ
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  DIMENSION AND TOLERANCING PER ASME14.5-2009.
- ASME 14.3-2009.
  D) DIMENSIONS ARE EXCLUSSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSSIONS.
  E) DRAWING FILE NAME: TO3PN03AREV1.
  F) FAIRCHILD SEMICONDUCTOR.

Figure 16. TO3PN, 3-Lead, Plastic, EIAJ SC-65

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